

REMARKS

With the above amendments, claims 17 and 26 have been amended to clarify that X² represents a 2,3-epoxypropoxyl group as supported on page 4, line 15 to page 6, line 4, of the present application. No new matter has been added to the application by the present amendment.

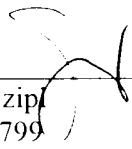
Accordingly, it is believed that the application is now in good condition for examination, and the Examiner's early and favorable action is respectfully requested.

The Examiner is reminded, however, that when filing this continuation application the applicants requested an interview to discuss the relationship of the present continuation application with the parent application, as well as the prior art.

Questions are welcomed by the below-signed attorney for applicants.

Respectfully submitted,

GRIFFIN & SZIPL, P.C.



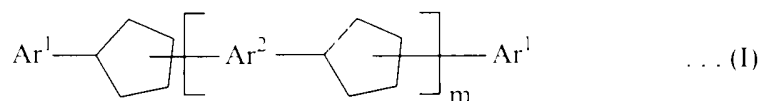
Joerg-Uwe Szips
Reg. No. 31,799

GRIFFIN & SZIPL, PC
Suite PH-1
2300 Ninth Street, South
Arlington, VA 22204

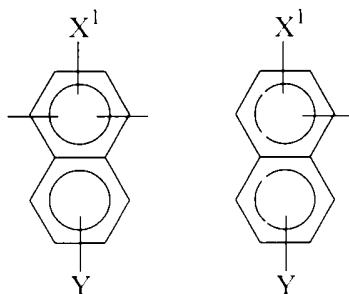
Telephone: (703) 979-5700
Facsimile: (703) 979-7429
Customer No.: 24203

VERSION WITH MARKINGS TO SHOW CHANGES MADE**In the Claims:**

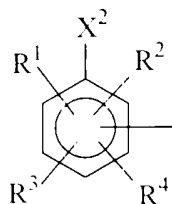
17. (Amended) A compound which is a cooligomer represented by the following general formula (I):



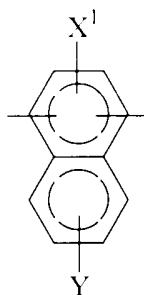
wherein m represents a positive number; Ar¹ represents at least one of monovalent organic groups selected from a fourth atomic group represented by



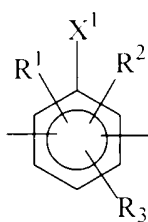
and a fifth atomic group represented by



Ar² represents at least one of divalent organic groups selected from a first atomic group represented by

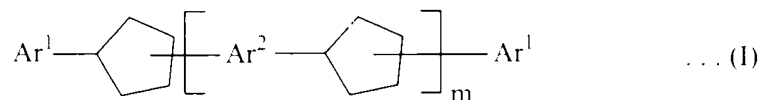


and a second atomic group represented by

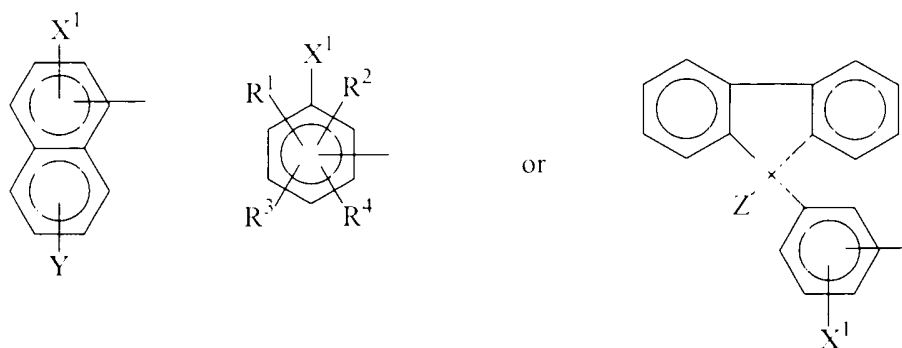


X^1 represents a 2,3-epoxypropoxyl group; X^2 represents a 2,3-epoxypropoxyl group; Y represents a hydrogen atom, a hydroxyl group or a 2,3-epoxypropoxyl group; and R^1 to R^4 are each a group selected independently from a hydrogen atom, an alkyl group and an aryl group having 1 to 10 carbon atoms and a halogen atom; and contains in one molecule at least one of the first atomic group and the fourth atomic group and at least one of the second atomic group and the fifth atomic group.

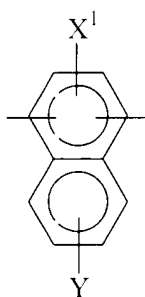
26. (Amended) An epoxy resin molding material for encapsulating electronic devices which comprises at least one of a compound represented by the following general formula (I):



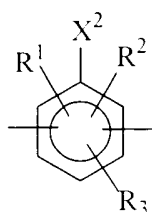
wherein m represents 0; Ar^1 represents at least one of monovalent organic groups represented respectively by



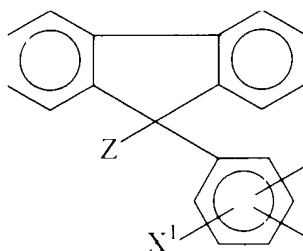
; Ar^2 represents at least one of divalent organic groups selected from the group consisting of a first atomic group represented by



a second atomic group represented by



and a third atomic group represented by



X^1 represents a 2,3-epoxypropoxyl group; X^2 represents a 2,3-epoxypropoxyl group; Y represents a hydrogen atom, a hydroxyl group or a 2,3-epoxypropoxyl group; Z represents a hydrogen atom, a phenyl group, a hydroxyphenyl group or a 2,3-epoxypropoxyphenyl group; and R^1 to R^4 are each a group selected independently from the group consisting of a hydrogen atom, an alkyl group and an aryl group having 1 to 10 carbon atoms and a halogen atom;

wherein, in formula (I), the Ar^1 groups are present in the 1 and 3 positions of the cyclopentane ring.